HKCA Lo Pan Scholarship

Established in 2023, the HKCA Lo Pan Scholarship is our signature youth empowerment programme after YMS. It aims at recognizing those students with outstanding academic results, community service, leadership, integrity and with a view to enhancing commitments in joining the construction industry after graduation.

gradation.	
Award	 Each awarded student will receive a grant of HK\$30,000.
Value/	Personal Development
Benefits	Career Opportunities
	Volunteer Services
Eligibility	The scholarship is open to all local students studying construction related disciplines at
	any local universities.
	1. A full-time student who will continue their Year 3/4 full-time bachelor's study in
	construction related disciplines at one of the Hong Kong's universities;
	2. Having a Cumulative Grade Point Average (CGPA) of at least 3.5 on a 4.0 scale
	and eligible for next year's admission by a Hong Kong university;
	3. A local student (e.g. holder of HKID Card (Permanent) or Permit for Proceeding
	to Hong Kong and Macau (One-way Permit));
	4. Aged 25 or below (i.e. born on or after 1 September 1998); and
	5. Proactively participating in community services, with leadership, integrity and
	commitments in joining the construction industry after graduation.
Application	The application period will close on 30 November 2023 (Thursday) by 23:59:59
Deadline	
Details	Eligible applicants should submit application by email to wincychan@hkca.com.hk
	For the application form and more details, please visit:
	https://drive.google.com/drive/folders/19dCB9Prixixqxl15LzBEW54NZbSvSc55
Enquiry	HKCA Secretariat
	Ms Wincy Chan
	Email: wincychan@hkca.com.hk
	Tel: 3978 8420
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